ASSOCIATION CONNECTIN ELECTRONICS INDUSTRIE	© Copyright 2005. IPC, international and Pan-Ar	Bannockb	urn, Illinois. A	ll rights reserved untions.	nder both	This docume level parts, t	ent is a declarat he declaration e	ion of the su encompasses	ibstances v s all lower	within the manufactur level materials for w	rer listed i hich the r	tem. Note: it nanufacturer	f the item is an as has engineering	sembly with lower responsibility.	
1752-21.1					Form Type Distribute	e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					als and Mfg Information				
Supplier Inform	nation														
Company name*			Company unique ID				Unique ID Authority				Response Date*				
onsemi										2023-06-08					
Contact Name			Title - Contact				Phone - Contact*				Email - Contact*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative				Phone - Representative*			Email - Representative*					
Product-Env-Stewa	ards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Requeste	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date Version Manufacturing Site		Ianufacturing Site		Weight*	UOM	Unit Type		
		NC7SP08P5X UL		ULP 2-Input AND Gate			2023-06-08		С	CNS		6.1753	mg	Each	
Manufacturing	Proccess Information	1													
Terminal Plating / Grid Array Material Te			erminal Base Alloy J-STD-020 MSI		L Rating	Peak Process Body Temperatu		emperatur	ure Max Time at Peak Temper		ture Numb	er of Reflow Cyd	eles		
Matte Tin (Sn) - annealed CU A			U Alloy	1			260 C 30			seconds 3					
Comments															
evel 1 - maximum t	ime at peak temperature o	luring sol	dering is 10-3	0 seconds											
or more informati	on regarding material con	position j	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	oHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl hthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.2027	mg	Supplier	Silicon (Si)	7440-21-3		0.2027	mg
Die Attach Epoxy	0.0202	mg	Supplier	Silver (Ag)	7440-22-4		0.0186	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.0016	mg
Lead Frame	3.2956	mg	Supplier	Zinc (Zn)	7440-66-6		0.004	mg
			Supplier	Iron (Fe)	7439-89-6		0.0774	mg
			Supplier	Copper (Cu)	7440-50-8		3.2132	mg
			Supplier	Phosphorus (P)	7723-14-0		0.001	mg
Mold Compound-Black	2.4264	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.7037	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0243	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1.6985	mg
Plating	0.2	mg	Supplier	Tin (Sn)	7440-31-5		0.2	mg
Wire Bond - Au	0.0304	mg	Supplier	Gold (Au)	7440-57-5		0.0304	mg